

5 é / Descriptions

(8)2 (3) D}© %-eO Yÿ eO ü`Ò U- P Á' ä ¢ è † † Ð • ož
 (8)2 (3) , 4⁻ ä 3 5 9, +: k ä ¢ † 9 y è y • ž è ož
 (8)2 (3) Ä Ä³ o 4 9 5: / x k ... ± ¥ ~ ^ 3 o ` • 9 q • ' ò ± 3 o 4 U
 - P Á • ož (8)2 (3) Ä Ä - k y k v k ? è ^ ñ Ä P ñ ~ } ' k w W
 • ž ô 3 o zož ¥ / Ì N N ô Ñ ò — < k - 9 % 2 ä ~ } eO Yÿ ê eO ü`Ò U- P x ž •
 ^ _ _ ' Î D } • « ` ož

The BRCL3230BMC series product is a high integration solution for lithium-ion/polymer battery protection. BRCL3230BMC contains advanced power MOSFET, high-accuracy voltage detection circuits and delay circuits.

BRCL3230BMC is put into an ultra-small SOT23-3 package makes it an ideal solution in limited space of battery pack. BRCL3230BMC has all the protection functions required in the battery application including overcharging, overdischarging, overcurrent and load short circuiting protection etc. The low standby current drains little current from the cell while in storage. The device is not only targeted for digital cellular phones, but also for any other Li-Ion and Li-Poly battery-powered information appliances requiring long-term battery life.

□^a / Features

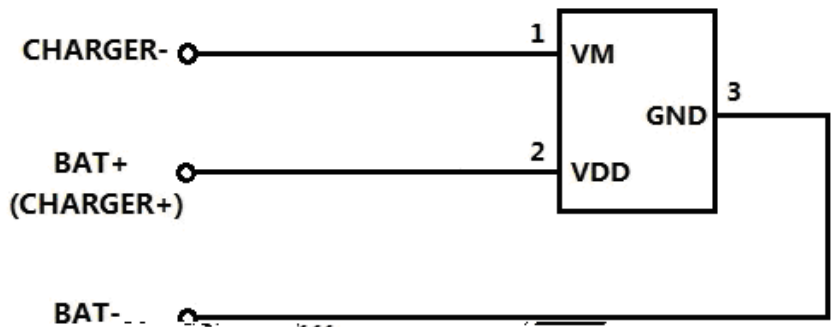
- < Ä B ¢ è ^ | S S ⁻ ä 3 5 9, +: z
- < Ý 4 / x 9 5: z
- < Ä B ¢ è 8) k — ~ ^ Ü ~ ^ z
- < “ ‘ z
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- < < v ‘ y y v k y v k ¿ ú ? è v z
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- < < P - k • ž • Ä B — k ä ¢ † 9 y z
- < z² Á v k 3 o W • v y [' - Ñ v y [' !
- < —) Í D }
- < Integrate advanced power MOSFET with Equivalent of 25m R_{DS(ON)};
- < Ultra-small SOT23-3 package;
- < Internal integration RC without any peripheral devices;
- < Over-temperature Protection;
- < Overcharge Current Protection;
- < Three-step Overcurrent Detection: Overdischarge Current1, Overdischarge Current2, Load Short Circuiting ×
- < Charger detection function;
- < 0V battery charging function, delay times are generated inside, High-accuracy voltage detection.
- < Low Current Consumption, Operation Mode: 3.0 A typ, Power-down Mode: 1.7 A typ ;
- < HF Product;

Ð ÷ / Applications

% / eO Yÿ P Á zeO ü`Ò P Á ož

One-Cell lithium-ion battery pack; Lithium-Polymer battery pack.

Typical Application

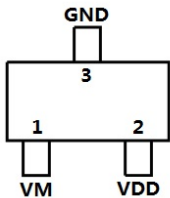
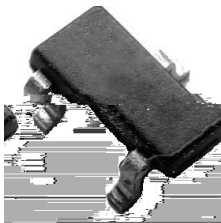


Notes

(1) The chip power consumption shall not exceed the maximum power consumed by the package.

(2) This product has anti-static protection function, but do not exceed the maximum capacity of the product to withstand static electricity.

Pinning



Symbol	Label	Description
CHARGER-	VM	The negative terminal of the charger. The internal FET switch connects this terminal to GND.
BAT+ (CHARGER+)	VDD	Power Supply
BAT-	GND	Ground, connect the negative terminal of the battery to this pin.

Marking

See Marking Instructions.

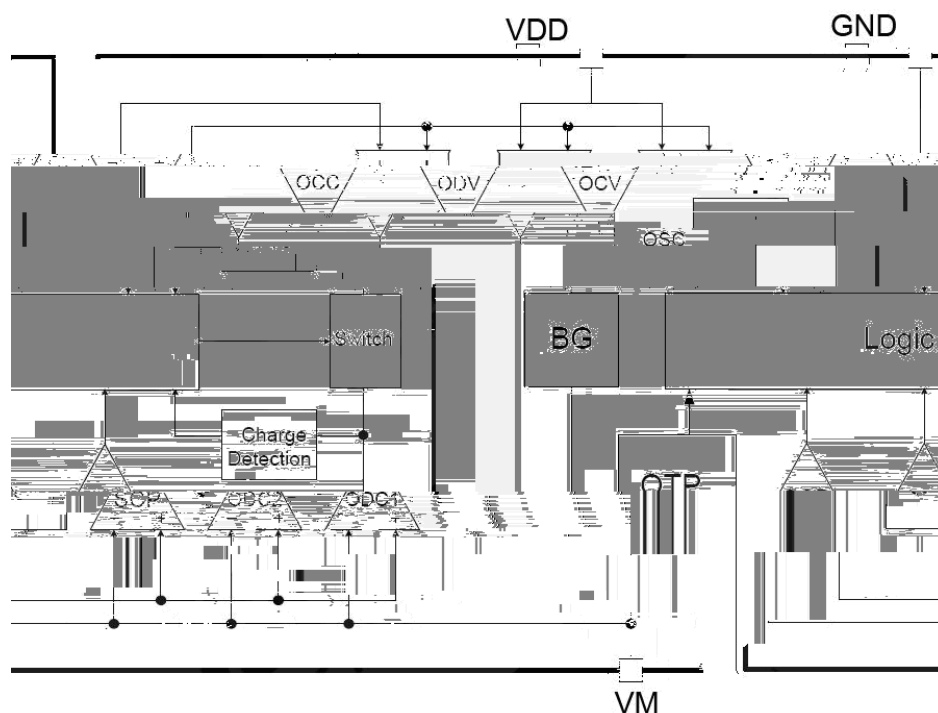
@ f/Parameter	... Z/Symbol	f > /Value	% y/Unit
V _{DD} input pin voltage	V _{IN}	-0.3 to +6	V
V _M input pin voltage	V _{VM}	-6 to +10	V
Power Dissipation	P _D	400	mW
Maximum Junction Temperature	T _J	125	
Lead Temperature	T _L	300	
Operating Junction Temperature	T _{opr}	-40 to +85	
Storage Temperature	T _{stg}	-55 to +150	
Package Thermal Resistance	R _{JA}	250	/W
	R _{Jc}	130	/W
ESD	ESD	2000	V

@ f/Parameter	... Z /Symbol	y i Ú ^ /Test Condition	Â 4 > /Min	Á ° > /Typ	Â Ý > /Max	% y /Unit
Detection voltage						
Overcharge Detection Voltage						
Overcharge Release Voltage	V _{CL}	VV				

Electrical Characteristics ($T_a = 25^\circ\text{C}$)

Equivalent FET on Resistance						
Equivalent FET on Resistance	R_{DS}	$V_{DD}=3.6\text{V}$ $I_{VM}=1\text{A}$	15	25	40	m
Over temperature protection						
Over Temperature Protection	OTP		125	140	155	
Over Temperature Recovery Degree	OTPR		100	115	130	
Delay time						
Overcharge Current Detection Delay Time	T_{OCC}	$V_{DD}=3.6\text{V}$	5.6	8	10.4	ms
Overcharge Voltage Detection Delay Time	T_{CU}	$V_{DD}=3.6\text{V} \sim 4.4\text{V}$	95	135	175	ms
Overdischarge Voltage Detection Delay Time	T_{DL}	$V_{DD}=3.6\text{V} \sim 2.0\text{V}$	25	35	45	ms
Overdischarge Current1 Detection Delay Time	T_{IOV1}	$V_{DD}=3.6\text{V}$	5.6	8	10.4	ms
Overdischarge Current2 Detection Delay Time	T_{IOV2}	$V_{DD}=3.6\text{V}$	0.7	1	1.3	ms
Load Short-Circuiting Detection Delay Time	T_{SHORT}	$V_{DD}=3.6\text{V}$		100	300	us

Function Block Diagram



× 5 é Functional Description

(8)2 (3)!O P 9y vkw* ••- ~êž úk' %-U- eO P kœ
 - 9k y 9k - vk y vYC?è^ŌÑòC°ož©ĬÛ è•%ož359,+:]Ăăk
 ^| ŠÁ°> S Sož

The BRCL3230BMC monitors the voltage and current of a battery and protects it from being damaged due to overcharge voltage, overdischarge voltage, overdischarge current, and short circuit conditions by disconnecting the battery from the load or charger. The peripheral circuit is very simple. The MOSFET is integrated and its $R_{DS(ON)}$ is as low as 25m Ω typical.

n V € “ Normal Operating mode

òçZĂ yñ`~'oŌÑkÿß'%²+ø•k- yy iC1 ôEož _ŌÑf 3oW
 •%”ož

If no exception condition is detected, charging and discharging can be carried out freely. This condition is called the normal operating mode.

Ú - Ô 85Š Đ Overcharge Condition

“3oÚ^ - i kç P 9ă9 - y 9g<);h w4Ōž• ñ - 9 y•
 ž•g:);hê¾xk(8)2 (3)1¼•,+:Y 2- ož _ŌÑf - 9ŌÑož
 Y _ŌÑk - 9ŌÑ1tKyy
 g hç P 9z9 - t” 9g<)2h k(8)2 (3)ø•ÿß'k>ñ3oW•%”ož
 g hç N%² žúgy k(8)2 (3)ø•ÿß'k>ñ3oW•%”ožt”Ñòò yN
 žúey vyö v ſß' ĂB\$ÿ8â'k<3 9 ñ <g/8â' 3g9'h k
 (8)2 (3) yñ 9ek1 - 9f9>ăEñ <);kN Ūkç P 9z9 - y
 9g<);hk(8)2 (3)yöÊŌñ3oW•%”k x©òç P 9ă9 - y 9g<);h k
 /... žú©N5 k/ì- kÊŌñ3oW•%”k.À}^ñ P 9z9 - y 9g<);h ož
 PŪk”N žúy žkòç<3 9^9êz9 v y 9k/ì kÊŌñ3oW•%”ož
 hyç Pt- ñÝ - y 9g<);hw P 9ZĂ'ñ - y 9g<);hY k/
 ... %² UY- v Múk v y v C kW•k”³ P 9^— - yg<);hY ož
 x© Ž P©ĂĂŠ kç PN %² Múk P 9ky/^Jk ž v y v <k
 •ož

When the battery voltage becomes higher than the overcharge detection voltage (VCU) during charging under normal condition and the state continues for the overcharge detection delay time (TCU) or longer, the BRCL3230BMC turns the charging control FET off to stop charging. This condition is called the overcharge condition.

The overcharge condition is released in the following two cases:

g 1 h When the battery voltage drops below the overcharge release voltage (VCL), the BRCL3230BMC turns the charging control FET on and returns to the normal condition.

g 2 h When a load is connected and discharging starts, the BRCL3230BMC turns the charging control FET on and returns to the normal condition. The release mechanism is as follows: the discharging current flows through an internal parasitic diode of the charging FET immediately after a load is connected and discharging starts, and the VM pin voltage increases about 0.7 V (forward voltage of the diode) from the GND pin voltage momentarily.

Ú Ć 85Š Đ Overcharge Condition

The BRCL3230BMC detects this voltage and releases the overcharge condition. Consequently, in the case that the battery voltage is equal to or lower than the overcharge detection voltage (VCU), the BRCL3230BMC returns to the normal condition immediately, but in the case the battery voltage is higher than the overcharge detection voltage (VCU), the chip does not return to the normal condition until the battery voltage drops below the overcharge detection voltage (VCU) even if the load is connected. In addition, if the VM pin voltage is equal to or lower than the overcurrent 1 detection voltage when a load is connected and discharging starts, the chip does not return to the normal condition.

Note: If the battery is charged to a voltage higher than the overcharge detection voltage (VCU) and the battery voltage does not drop below the overcharge detection voltage (VCU) even when a heavy load, which causes an overcurrent, is connected, the overcurrent 1 and overcurrent 2 do not work until the battery voltage drops below the overcharge detection voltage (VCU). Since an actual battery has, however, an internal impedance of several dozens of mΩ, and the battery voltage drops immediately after a heavy load which causes an overcurrent is connected, the overcurrent 1 and overcurrent 2 work. Detection of load shortcircuiting works regardless of the battery voltage.

Ú Ź Ő 85Š Đ Overdischarge Condition

When the battery voltage drops below the overdischarge detection voltage (VDL) during discharging under normal condition and it continues for the overdischarge detection delay time (tDL) or longer, the BRCL3230BMC turns the discharging control FET off and stops discharging. This condition is called overdischarge condition. After the discharging control FET is turned off, the VM pin is pulled up by the RVMD resistor between VM and VDD in BRCL3230BMC. The current of the chip is reduced to the power-down current (IPDN). This condition is called power-down condition. The VM and VDD pins are shorted by the RVMD resistor. The power-down condition is released when a charger is connected and the potential difference between VM and VDD becomes typical or higher, at this time, the FET is still off. When the battery voltage becomes the overdischarge detection voltage (VDL) or higher (see note), the BRCL3230BMC turns the FET on and changes to the normal condition from the overdischarge condition.

Note: If the VM pin voltage is no less than the charger detection voltage (VCHA), when the battery under overdischarge condition is connected to a charger, the overdischarge condition is released (the discharging control FET is turned on) as usual, provided that the battery voltage reaches the overdischarge release voltage (VDR) or higher.

Ú Z Ô W Š Đ Overcurrent Condition

3 o W • % " k ϕ y v ^ 9 ê ä 9 — > g < 3 9 ^ 9 ê ä 9 v y 9 h w 4 Ô ž
 • ñ y v y • ž • (8) 2 (3) ¼ • y , + : k 2 y ož _ Õ Ñ f y v Õ Ñ g
 , y v k y v y ž ú ? è v h ož y v Õ Ñ < 3 y - 4 * t 8 < 3 9 Š Ě ? N 4 ož ϕ %²
 ž ú N k < 3 9 ^ 9 < * * x > ž ú Š 9 ož
 9 < 3 y - 4 * \$ • N 8 < 3 9 Š k ϕ ž ú • • k < 3 9 t ñ^a y ož ϕ y ñ < 3 y z 9 v
 y 9 k / Ì > ñ 3 o Ù Á ož

When the discharging current becomes equal to or higher than a specified value (the VM pin voltage is equal to or higher than the overcurrent detection voltage) during discharging under normal condition and the state continues for the overcurrent detection delay time or longer, the BRCL3230BMC turns off the discharging control FET to stop discharging. This condition is called overcurrent condition. (The overcurrent includes overcurrent, or load shortcircuiting.) The VM and GND pins are shorted internally by the RVMS resistor under the overcurrent condition. When a load is connected, the VM pin voltage equals the VDD voltage due to the load.

Because of the connection between the VM and the GND by the RVMS resistor k when the load is removed, the VM pin goes back to the GND potential since the VM pin is shorted the GND pin with the RVMS resistor. Detecting that the VM pin potential is lower than the overcurrent detection voltage (VIOV1), the IC returns to the normal condition.

• n ñ Ô Ô W ó Z Abnormal Charge Current Detection

3 o - ž k ô ϕ < 3 9 ' ñ - y 9 Y <) . ' k w 4 Ô ž • Ý - v y • ž ž •
 :) ; k (8) 2 (3) ¼ • - , + : 2 - ož _ Õ Ñ f ' o - v y ož
 • • - ~ k < 3 y - 4 * \$ • 9 ä 9 - ~ y 9 <) . ' ž k ' o - v % " † " ož 9 < P
 - i - ' ä 9 3 o v - y k P 9 @ z P 3 " g < - ž k ' o - v y
 1 W • ož

If the VM pin voltage drops below the charger detection voltage (VCHA) during charging under the normal condition and it continues for the overcharge detection delay time (TCU) or longer, the BRCL3230BMC turns the charging control FET off and stops charging. This action is called abnormal charge current detection.

Abnormal charge current detection is released when the voltage difference between VM pin and GND pin becomes higher than the charger detection voltage (VCHA) by separating the charger. Since the 0 V battery charging function has higher priority than the abnormal charge current detection function, abnormal charge current may not be detected by the product with the 0 V battery charging function while the battery voltage is low.

Ž É • 5 Š Đ Load Short-circuiting Condition

ò ϕ < 3 9 ä 9 ? è ' 9 g < 9 . 5 8 : h k w 4 Ô ž • Ý ? è y • ž • g Z 9 . 5 8 : h k
 (8) 2 (3) 1 ž ú • • 2 y ož ϕ < 3 9 z 9 ? è ' 9 g < 9 . 5 8 : h ž k † ò ž ú t g
 " k ž ú ? è Õ Ñ 1 † " ož

If voltage of VM pin is higher short circuiting protection voltage (VSHORT) and it continues for the tSHORT or longer, the BRCL3230BMC will stop discharging and battery is disconnected from load. This status is released when voltage of VM pin is higher than short protection voltage (VSHORT), such as when disconnecting the load.

< 0V Battery Charging Function

4 9+]Æ y ñ < P g Ç - ožÇ - ~V ž kk* Ä B 8 â' Û Ě P g -
 kÇ P 9 ä 9 y y 9 g < * 2 h ž k' /) μ 3 o W • Û Á ož
 h y î? ¶ y e P k a • t Ç) - k © e O P Ô Å Ð ož - ¢ | P ^ • Æ k
 G • ñ Æ 1 P © k À Õ a • g < P - k © W 2 g < P - ož
 a • g < P - A - v y i - ' ¼ ä ož œ 4 ... a • g < P -
 /) k " P 9 û z ž ~ k ò - ož P 9 z 9 y y 9 g < * 2 h Y ž k
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 Ç P † %) N ' è ž k è U k μ 3 o % " k 4 ž — c y ož ò Ç D ÿ _ ě » k
 ... < 3 ' 9 ^ 9 - 4 * 9 g 1 < 3 - 4 * ? è ê N - ~ h k < U Y μ 3 o % " ož

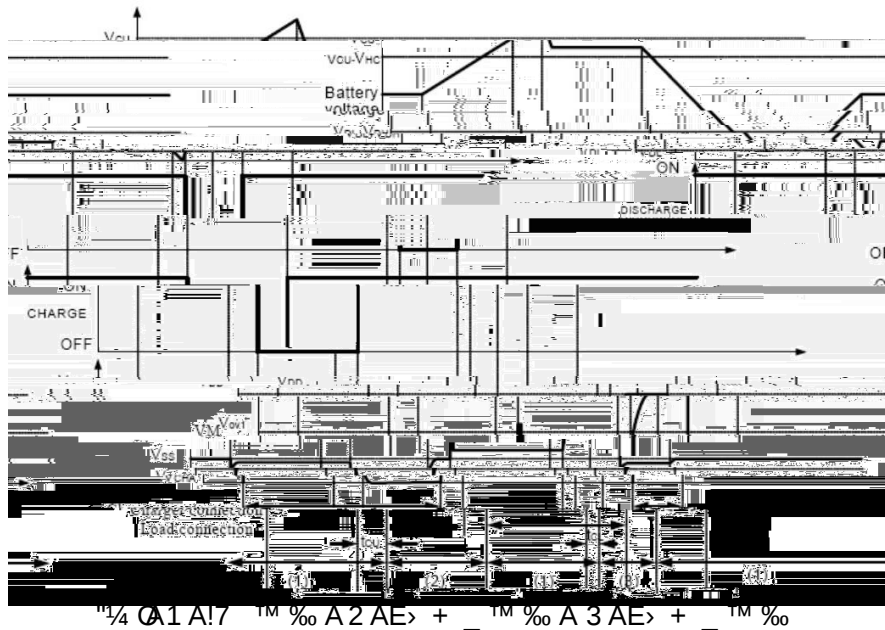
This function enables the charging of a connected battery whose voltage is 0V by self-discharge. When connects to a charger , the discharging control FET is off and the charging current flows through the internal parasitic diode in the discharging control FET. If the battery voltage becomes equal to or higher than the overdischarge release voltage (VDL), the normal condition returns.

Notes

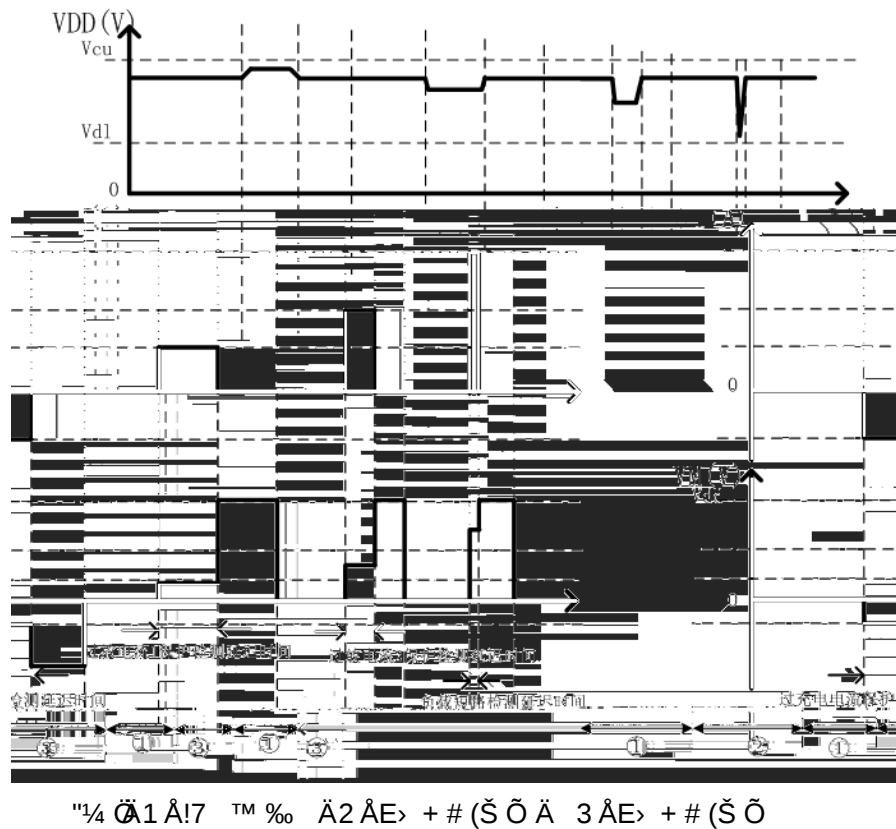
- (1) Some battery providers do not recommend charging of completely discharged batteries. Please refer to battery providers before the selection of 0 V battery charging function.
- (2) The 0V battery charging function has higher priority than the abnormal charge current detection function. Consequently, a product with the 0 V battery charging function charges a battery and abnormal charge current cannot be detected during the battery voltage is low.
- (3) When a battery is connected to the IC for the first time, the IC may not enter the normal condition in which discharging is possible. In this case, set the VM pin voltage equal to the GND voltage (short the VM and GND pins or connect a charger) to enter the normal condition.

• } ¢ Timing Chart

Ú Ñ x Ú Z Ô 8 6 Z Overcharge And Overdischarge Detection

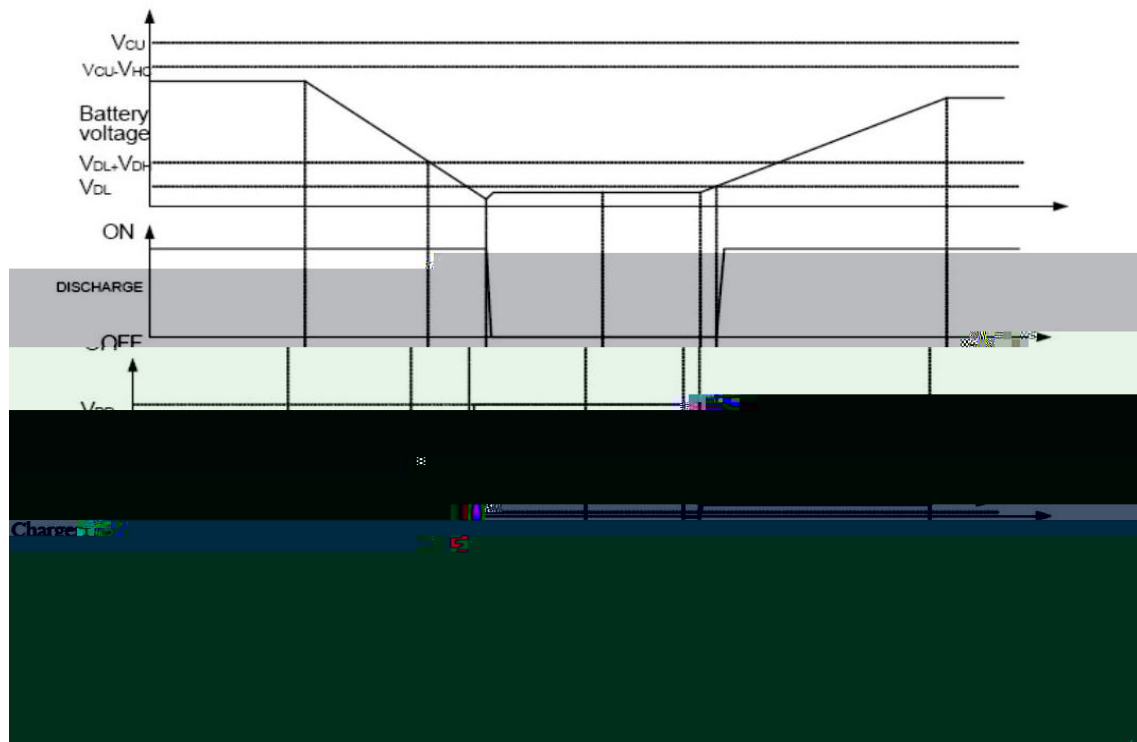


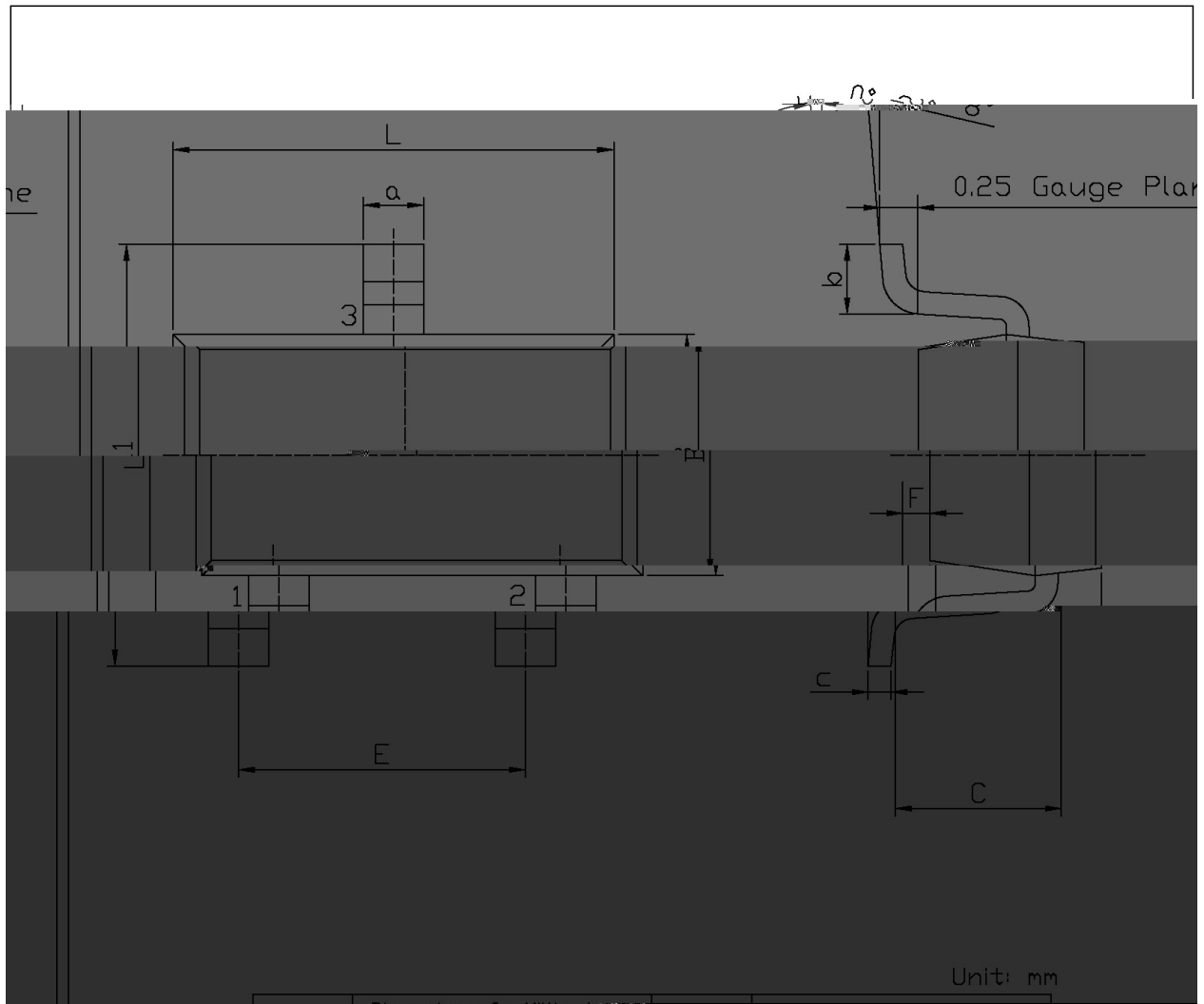
Ú Ñ Z Ô W 6 Z 5 \ K X I N G Overdischarge Current Detection



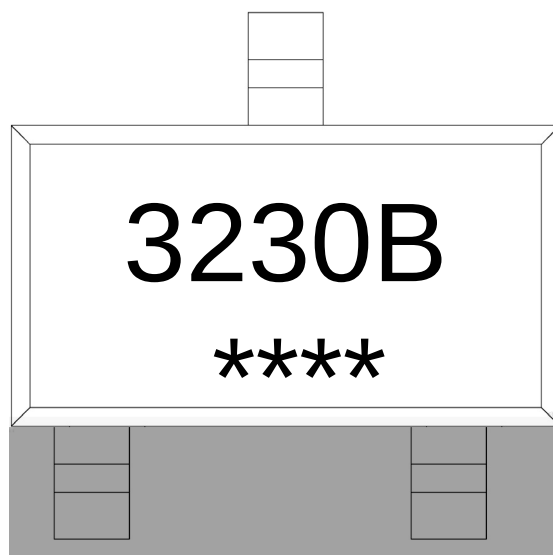
Timing Chart

Charger Detection



$\varnothing \square =) \phi$ / Package Dimensions

, My f / Marking Instructions



a ϕ y

(y

D } ° Z

y

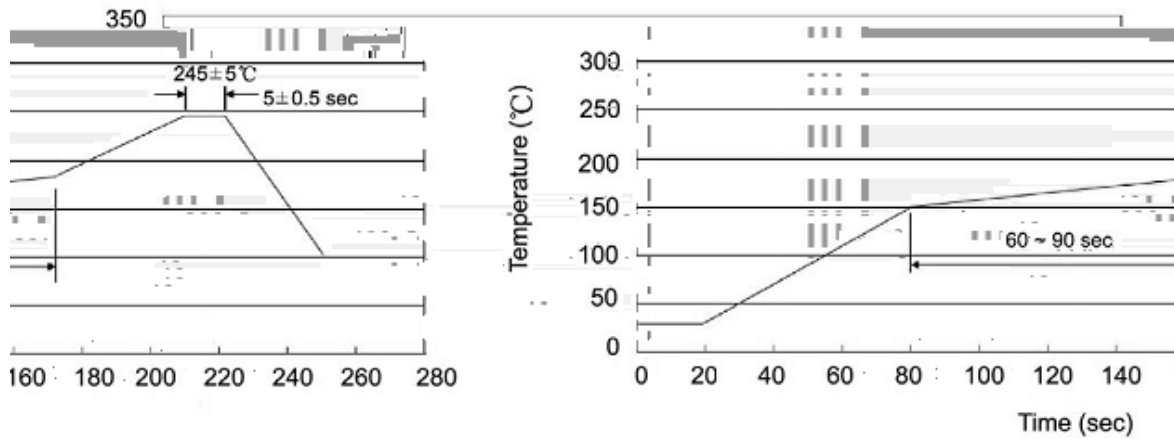
ÿ D Z W A k š ÿ D Z J ož

Note:

3230B: Product Type.

****: Lot No. Code, code change with Lot No.

šWD t... • Žč (x/) / :KSVKXGZ[XK 6XULORK LUX /8 8KLRU] 9URJKXOTM 6



a ç y

10• Ä ½ "† 150 ½180 - k ž • 60 ½90sec;

20• Q > "† 245 r5 - k ž • 4 Ò 5 r0.5sec;

30•D N ò i Ò 0 ,† 2 ½10 - /sec.

Note:

1.Preheating:150±180 - , Time:60~90sec.

2.Peak Temp.:245 r5 - , Duration:5 r0.5sec.

3. Cooling Speed: 2±0 - /sec.

ÂD /Cã p ¯ »] / Resistance to Soldering Heat Test Conditions

"† y 260 r5 -

ž • y 10 r1 sec.

Temp.:260 r5 -

Time:10 r1 sec

G P á / Packaging SPEC.

2 & x / REEL

6GIQGMK	YK	TOZY xfo	*OSKTYOUT x>*	[TOZySS
/x¥"	TOZY 30000 /TTK	KKOZU^ /TTK	KKX(U^KY 5	ZKKZU5[ZKX(U
	Q 2&	2& "	Q "	" " " " Q "
SOT-23-3	3,000	10	30,000	4
			120,000	s x8
			210×205×205	445×230×435

„Đ y f / Notices